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ELECTRONICS

MacDermid Alpha to Present Latest Silver Sinter Technology at the EPP Innovations Forum

(Waterbury, CT USA) – 26th Feb 2020 – The Assembly Solutions division of MacDermid Alpha Electronics Solutions, a world leader in the production of electronics soldering and bonding materials, will present on the Silver Sintering Process at the EPP Innovations Forum on Thursday 5th March in Böblingen, Germany.

Ralph Christ, Customer Technical Support Manager DACH Region at MacDermid Alpha will present *Silver Sintering, the New Soldering?* at the event and will discuss the silver sintering process and its benefits compared to traditional soldering processes, as well as highlighting MacDermid Alpha's range of [ALPHA® Argomax® silver sinter materials](#). "Silver Sintering is a proven technology that overcomes many of the thermal dissipation, power cycling and high temperature stability challenges associated with power module interconnects," comments Ralph. "MacDermid Alpha's range of ALPHA Argomax silver sinter technology products are designed to exceed the demanding quality and reliability standards of the power semiconductor industry."

To register for the EPP Innovations Forum go to: <https://epp.industrie.de/innovationsforum-deutschland/>. For more information on ALPHA Argomax products visit MacDermidAlpha.com

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